

## CY2DM1502

# 1:2 CML Fanout Buffer with Selectable Clock Input

#### Features

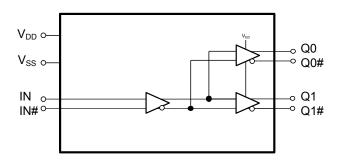
- One current mode logic (CML), High-speed current steering logic (HCSL), or low-voltage positive emitter-coupled logic (LVPECL) input pair distributed to two CML output pairs
- 20-ps maximum output-to-output skew
- 480-ps maximum propagation delay
- 0.15-ps maximum additive RMS phase jitter at 156.25 MHz (12-kHz to 20-MHz offset)
- Up to 1.5 GHz operation
- 8-pin thin shrunk small outline package (TSSOP) package
- 2.5-V or 3.3-V operating voltage <sup>[1]</sup>
- Commercial and industrial operating temperature range

#### Logic Block Diagram

#### **Functional Description**

The CY2DM1502 is an ultra-low noise, low-skew, low-propagation delay 1:2 CML, HCSL, or LVPECL to CML fanout buffer targeted to meet the requirements of high-speed clock distribution applications. The device has a fully differential internal architecture that is optimized to achieve low additive jitter and low skew at operating frequencies of up to 1.5 GHz.

For a complete list of related documentation, click here.



Note

1. Input AC-coupling capacitors are required for voltage-translation applications.



# CY2DM1502

## Contents

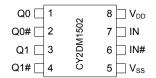
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#### Pinouts

#### Figure 1. 8-pin TSSOP Package pinout



## **Pin Definitions**

| Pin No. | Pin Name        | Pin Type | Description                               |
|---------|-----------------|----------|---|
| 1, 3    | Q(0:1)          | Output   | CML output clocks                         |
| 2, 4    | Q(0:1)#         | Output   | CML complementary output clocks           |
| 5       | V <sub>SS</sub> | Power    | Ground                                    |
| 6       | IN#             | Input    | CML/HCSL/LVPECL complementary input clock |
| 7       | IN              | Input    | CML/HCSL//LVPECL input clock              |
| 8       | V <sub>DD</sub> | Power    | Power supply                              |



## **Absolute Maximum Ratings**

| Parameter                       | Description   | Condition           | Min   | Max  | Unit |
|---------------------------------|---|---------------------|---|--|------|
| V <sub>DD</sub>                 | Supply voltage  | Nonfunctional       | -0.5  | 4.6  | V    |
| V <sub>IN</sub> <sup>[2]</sup>  | Input voltage, relative to $V_{SS}$                         | Nonfunctional       | -0.5  | lesser of<br>4.0 or<br>V <sub>DD</sub> + 0.4 | V    |
| V <sub>OUT</sub> <sup>[2]</sup> | DC output or I/O voltage, relative to $V_{SS}$              | Nonfunctional       | -0.5  | lesser of<br>4.0 or<br>V <sub>DD</sub> + 0.4 | V    |
| Τ <sub>S</sub>                  | Storage temperature   | Nonfunctional       | -55   | 150  | °C   |
| ESD <sub>HBM</sub>              | Electrostatic discharge (ESD) protection (Human body model) | JEDEC STD 22-A114-B | 2000  | -  | V    |
| LU                              | Latch up  |                     | Meets or exceeds JEDEC Spec<br>JESD78B IC Latch-up Test |  |      |
| UL-94                           | Flammability rating   | At 1/8 in           | V-0   |  |      |
| MSL                             | Moisture sensitivity level                                  |                     | 3   |  |      |

# **Operating Conditions**

| Parameter       | Description                   | Condition  | Min   | Max   | Unit |
|-----------------|-------------------------------|--|-------|-------|------|
| V <sub>DD</sub> | Supply voltage                | 2.5-V supply   | 2.375 | 2.625 | V    |
|                 |                               | 3.3-V supply   | 3.135 | 3.465 | V    |
| T <sub>A</sub>  | Ambient operating temperature | Commercial   | 0     | 70    | °C   |
|                 |                               | Industrial   | -40   | 85    | °C   |
| t <sub>PU</sub> | Power ramp time               | Power-up time for V <sub>DD</sub> to reach minimum specified voltage (power ramp must be monotonic). | 0.05  | 500   | ms   |



## **DC Electrical Specifications**

(V<sub>DD</sub> = 3.3 V ± 5% or 2.5 V ± 5%; T<sub>A</sub> = 0 °C to 70 °C (Commercial) or –40 °C to 85 °C (Industrial))

| Parameter                      | Description   | Condition   | Min                   | Max                   | Unit |
|--------------------------------|---|---|-----------------------|-----------------------|------|
| I <sub>DD</sub>                | Operating supply current                                    | All CML outputs floating (internal I <sub>DD</sub> )          | -                     | 50                    | mA   |
| V <sub>IH</sub>                | Input high voltage,<br>CML/HCSL/LVPECL inputs<br>IN and IN# |   | -                     | V <sub>DD</sub> + 0.3 | V    |
| V <sub>IL</sub>                | Input low voltage,<br>CML/HCSL/LVPECL inputs<br>IN and IN#  |   | -0.3                  | _                     | V    |
| V <sub>ID</sub> <sup>[3]</sup> | Input differential amplitude                                | See Figure 2 on page 7  | 0.4                   | 1.0                   | V    |
| V <sub>ICM</sub>               | Input common mode voltage                                   | See Figure 2 on page 7  | 0.2                   | V <sub>DD</sub> – 0.2 | V    |
| I <sub>IH</sub>                | Input high current,<br>CML/HCSL/LVPECL inputs<br>IN and IN# | Input = $V_{DD}^{[4]}$  | -                     | 150                   | μΑ   |
| I <sub>IL</sub>                | Input low current,<br>CML/HCSL/LVPECL inputs<br>IN and IN#  | Input = $V_{SS}^{[4]}$  | -150                  | _                     | μΑ   |
| V <sub>OH</sub>                | CML output high voltage                                     | Terminated with 50 $\Omega$ to V <sub>DD</sub> <sup>[5]</sup> | V <sub>DD</sub> – 0.1 | -                     | V    |
| V <sub>OL</sub>                | CML output low voltage                                      | Terminated with 50 $\Omega$ to V <sub>DD</sub> <sup>[5]</sup> | V <sub>DD</sub> – 0.7 | V <sub>DD</sub> – 0.3 | V    |
| C <sub>IN</sub>                | Input capacitance   | Measured at 10 MHz; per pin                                   | -                     | 3                     | pF   |

#### **Thermal Resistance**

| Parameter [6] | Description                              | Test Conditions   | 8-pin TSSOP | Unit |
|---------------|--|---|-------------|------|
| $\theta_{JA}$ | 0  | Test conditions follow standard test methods and procedures for measuring thermal impedance, in | 162         | °C/W |
| $\theta_{JC}$ | Thermal resistance<br>(junction to case) | accordance with EIA/JESD51.   | 29          | °C/W |

Notes

- V<sub>ID</sub> minimum of 400 mV is required to meet all output AC Electrical Specifications. The device is functional with V<sub>ID</sub> minimum of greater than 200 mV.
   Positive current flows into the input pin, negative current flows out of the input pin.
- 5. Refer to Figure 3 on page 7.
- 6. These parameters are guaranteed by design and are not tested.





## **AC Electrical Specifications**

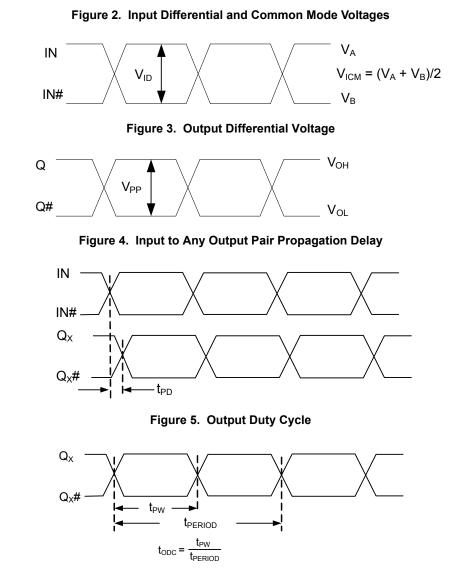
(V<sub>DD</sub> = 3.3 V ± 5% or 2.5 V ± 5%; T<sub>A</sub> = 0 °C to 70 °C (Commercial) or –40 °C to 85 °C (Industrial))

| Parameter                                       | Description  | Condition  | Min | Тур | Max  | Unit       |
|---|--|--|-----|-----|------|------------|
| F <sub>IN</sub>                                 | Input frequency  |  | DC  | -   | 1.5  | GHz        |
| F <sub>OUT</sub>                                | Output frequency   | F <sub>OUT</sub> = F <sub>IN</sub>   | DC  | -   | 1.5  | GHz        |
| V <sub>PP</sub>                                 | CML differential output voltage  | Fout = DC to 150 MHz   | 250 | -   | 700  | mV         |
|   | peak-to-peak, single-ended. Terminated with 50 $\Omega$ to $\mathrm{V_{DD}}^{[5]}$ | Fout = >150 MHz to 1.5 GHz   | 250 | _   | 600  | mV         |
| t <sub>PD</sub> <sup>[7]</sup>                  | Propagation delay input pair to output pair  | Input rise/fall time < 1.5 ns<br>(20% to 80%)  | -   | -   | 480  | ps         |
| t <sub>ODC</sub> <sup>[8]</sup>                 | Output duty cycle  | 50% duty cycle at input<br>Frequency range up to 1 GHz   | 48  | -   | 52   | %          |
| t <sub>SK1</sub> <sup>[9]</sup>                 | Output-to-output skew  | Any output to any output, with same load conditions at DUT   | -   | _   | 20   | ps         |
| t <sub>sk1 d</sub> [9]                          | Device-to-device output skew   | Any output to any output between<br>two or more devices. Devices must<br>have the same input and have the<br>same output load.                       | -   | _   | 150  | ps         |
| PN <sub>ADD</sub>                               | Additive RMS phase noise<br>156.25-MHz Input                                       | Offset = 1 kHz   | -   | -   | -120 | dBc/<br>Hz |
|   | Rise/fall time < 150 ps<br>(20% to 80%)  | Offset = 10 kHz  | -   | -   | -130 | dBc/<br>Hz |
|   | V <sub>ID</sub> > 400 mV   | Offset = 100 kHz   | -   | -   | -135 | dBc/<br>Hz |
|   |  | Offset = 1 MHz   | -   | -   | -145 | dBc/<br>Hz |
|   |  | Offset = 10 MHz  | -   | -   | -153 | dBc/<br>Hz |
|   |  | Offset = 20 MHz  | -   | _   | -155 | dBc/<br>Hz |
| t <sub>JIT</sub> <sup>[10]</sup>                | Additive RMS phase jitter<br>(Random)  | 156.25 MHz,<br>12 kHz to 20 MHz offset;<br>input rise/fall time < 150 ps<br>(20% to 80%),<br>V <sub>ID</sub> > 400 mV                                | -   | _   | 0.15 | ps         |
| t <sub>R</sub> , t <sub>F</sub> <sup>[11]</sup> | Output rise/fall time  | 50% duty cycle at input,<br>20% to 80% of full swing<br>$(V_{OL}$ to $V_{OH})$<br>Input rise/fall time < 1.5 ns<br>(20% to 80%)<br>Measured at 1 GHz | _   | -   | 250  | ps         |

Notes











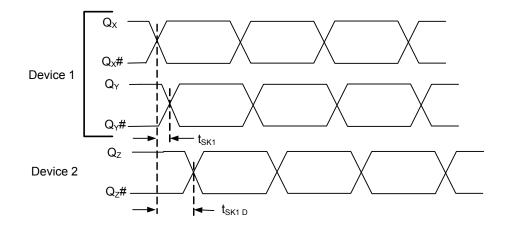
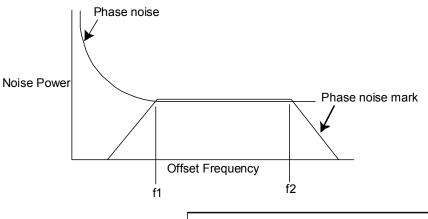
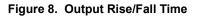


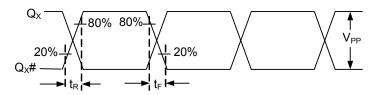
Figure 6. Output-to-Output and Device-to-Device Skew





RMS Jitter  $\propto \sqrt{\text{Area Under the Masked Phase Noise Plot}}$ 



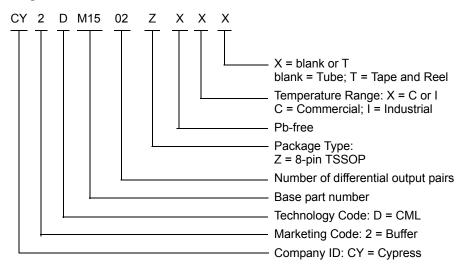




#### **Ordering Information**

| Part Number   | Туре                      | Production Flow             |
|---------------|---------------------------|-----------------------------|
| Pb-free       |                           |                             |
| CY2DM1502ZXI  | 8-pin TSSOP               | Industrial, –40 °C to 85 °C |
| CY2DM1502ZXIT | 8-pin TSSOP tape and reel | Industrial, –40 °C to 85 °C |

#### **Ordering Code Definitions**



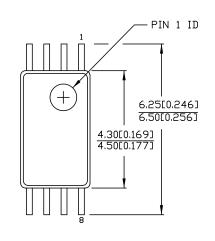




#### Package Diagram

Figure 9. 8-pin TSSOP (4.40 MM Body) Z08.173/ZZ08.173 Package Outline, 51-85093

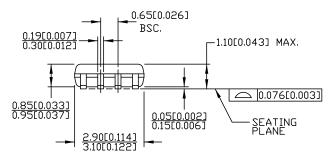
8 Lead TSSOP 4.40 MM BODY

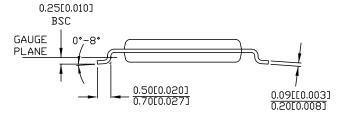


DIMENSIONS IN MMEINCHES] <u>Min.</u> Max.

REFERENCE JEDEC MD-153

|          | PART #         |
|----------|----------------|
| Z08.173  | STANDARD PKG.  |
| ZZ08.173 | LEAD FREE PKG. |





51-85093 \*E





#### Acronyms

#### Table 1. Acronyms Used in this Document

| Acronym | Description  |
|---------|--|
| CML     | current mode logic                                     |
| ESD     | electrostatic discharge                                |
| HBM     | human body model                                       |
| HCSL    | high-speed current steering logic                      |
| JEDEC   | joint electron devices engineering council             |
| LVDS    | low-voltage differential signal                        |
| LVCMOS  | low-voltage complementary metal oxide<br>semiconductor |
| LVPECL  | low-voltage positive emitter-coupled logic             |
| RMS     | root mean square                                       |
| TSSOP   | thin shrunk small outline package                      |

#### **Document Conventions**

#### **Units of Measure**

#### Table 2. Units of Measure

| Symbol | Unit of Measure                  |
|--------|----------------------------------|
| °C     | degree Celsius                   |
| dBc    | decibels relative to the carrier |
| GHz    | gigahertz                        |
| Hz     | hertz                            |
| kΩ     | kilohm                           |
| μA     | microampere                      |
| μF     | microfarad                       |
| μs     | microsecond                      |
| mA     | milliampere                      |
| ms     | millisecond                      |
| mV     | millivolt                        |
| MHz    | megahertz                        |
| ns     | nanosecond                       |
| Ω      | ohm                              |
| pF     | picofarad                        |
| ps     | picosecond                       |
| V      | volt                             |
| W      | watt                             |



# **Document History Page**

| Revision | ECN     | Orig. of<br>Change | Submission<br>Date | Description of Change  |
|----------|---------|--------------------|--------------------|--|
| **       | 2782891 | CXQ                | 10/09/09           | New Datasheet.   |
| *A       | 2838916 | CXQ                | 01/05/2010         | Changed status from "ADVANCE" to "PRELIMINARY".<br>Changed from 0.34 ps to 0.25 ps maximum additive jitter in "Features" on page 1 and in t <sub>JIT</sub> in the AC Electrical Specs table on page 4.<br>Added t <sub>PU</sub> spec to the Operating Conditions table on page 2.<br>Removed V <sub>OH</sub> spec maximum of V <sub>DD</sub> in the DC Electrical Specs table on page 3.<br>Changed V <sub>OL</sub> spec min from V <sub>DD</sub> - 0.6V to V <sub>DD</sub> - 0.7V; changed max from V <sub>DI</sub> - 0.4V to V <sub>DD</sub> - 0.3V in the DC Electrical Specs table on page 3.<br>Removed V <sub>OD</sub> spec of minimum 300 mV, maximum 450 mV in the DC Electrical Specs table on page 3.<br>Added R <sub>P</sub> spec in the DC Electrical Specs table on page 3. Min = 60 k $\Omega$ , Max = 140 k $\Omega$ .<br>Added a measurement definition for C <sub>IN</sub> in the DC Electrical Specs table on page 3.<br>Added a measurement definition for C <sub>IN</sub> in the DC Electrical Specs table on page 3.<br>Added V <sub>PP</sub> spec to the AC Electrical Specs table on page 4. V <sub>PP</sub> max = 700 mV for DC - 150 MHz and max = 600 mV for 150 MHz to 1.5 GHz. V <sub>PP</sub> min = 250 mV over the entire range.<br>Changed letter case and some names of all the timing parameters in the AC Electrical Specs table on page 4.<br>Added conditive phase noise mask specs by 3 dB in in the AC Electrical Specs table on page 4.<br>Added condition to t <sub>R</sub> and t <sub>F</sub> specs in the AC Electrical specs table on page 4.<br>Added condition to t <sub>R</sub> and t <sub>F</sub> specs in the AC Electrical specs table on page 4.<br>Added condition to t <sub>R</sub> and t <sub>F</sub> specs in the AC Electrical specs table on page 4.<br>Added condition to t <sub>R</sub> and t <sub>F</sub> specs in the AC Electrical specs table on page 4.<br>Added condition to t <sub>R</sub> and t <sub>F</sub> specs in the AC Electrical specs table on page 4.<br>Added condition to t <sub>R</sub> and t <sub>F</sub> specs in the AC Electrical specs table on page 4. |
| *В       | 3011766 | CXQ                | 08/20/2010         | Changed from 0.25 ps to 0.11 ps maximum additive jitter in "Features" on page 1 and in t <sub>JIT</sub> in the AC Electrical Specs table.<br>Added note 3 to describe I <sub>IH</sub> and I <sub>IL</sub> specs.<br>Removed reference to data distribution from "Functional Description".<br>Changed R <sub>P</sub> for diff inputs from 100 k $\Omega$ to 150 k $\Omega$ in the Logic Block Diagran and from 60 k $\Omega$ min / 140 k $\Omega$ max to 90 k $\Omega$ min / 210 k $\Omega$ max in the DC Electrical Specs table.<br>Added max V <sub>ID</sub> of 1.0V in DC Electrical Specs table.<br>Updated phase noise specs for 1 k/10 k/100 k/1 M/10 M/20 MHz offset to -120/-130/-135/-150/-150/electrical Spectively, in the AC Electrical Spec table.<br>Added "Frequency range up to 1 GHz" condition to t <sub>ODC</sub> spec.<br>Updated package diagram.<br>Added Acronyms and Ordering Code Definition.  |
| *C       | 3017258 | CXQ                | 08/27/2010         | Corrected Output Rise/Fall time diagram.   |
| *D       | 3100234 | CXQ                | 11/18/2010         | Updated Phase jitter to 0.15ps max from 0.11ps max.<br>Changed V <sub>IN</sub> and V <sub>OUT</sub> specs from 4.0V to "lesser of 4.0 or V <sub>DD</sub> + 0.4"<br>Removed 200mA min LU spec, replaced with "Meets or exceeds JEDEC Spec<br>JESD78B IC Latchup Test"<br>Removed R <sub>P</sub> spec for differential input clock pins IN <sub>X</sub> and IN <sub>X</sub> #.<br>Changed C <sub>IN</sub> condition to "Measured at 10 MHz".<br>Changed PN <sub>ADD</sub> specs for 1MHz, 10MHz, and 20MHz offsets.<br>Added condition "Measured at 1 GHz" to t <sub>R</sub> , t <sub>F</sub> specs.   |
| *E       | 3137726 | CXQ                | 01/13/2011         | Removed "Preliminary" status heading.<br>Removed resistors from IN/IN# in Logic Block Diagram.   |
| *F       | 3090938 | CXQ                | 02/25/2011         | Post to external web.  |



# Document History Page (continued)

| Document Title: CY2DM1502, 1:2 CML Fanout Buffer with Selectable Clock Input<br>Document Number: 001-56315 |         |                    |                    |  |  |  |  |
|--|---------|--------------------|--------------------|--|--|--|--|
| Revision   | ECN     | Orig. of<br>Change | Submission<br>Date | Description of Change  |  |  |  |
| *G   | 3410372 | PURU               | 10/18/2011         | Adding HCSL to Features, Functional Description, Pin Definitions, and DC Electrical Specifications sections. The min value of $V_{ICM}$ is changed from 0.5 to 0.2 in DC Electrical Specifications.  |  |  |  |
| *H   | 3878396 | PURU               | 01/21/2013         | Updated to new template.   |  |  |  |
| *  | 4587249 | PURU               | 12/04/2014         | Updated Functional Description:<br>Added "For a complete list of related documentation, click here." at the end.<br>Updated Ordering Information:<br>Removed the prune part numbers CY2DM1502ZXC and CY2DM1502ZXCT.<br>Updated Package Diagram:<br>spec 51-85093 – Changed revision from *D to *E. |  |  |  |
| *J   | 5272915 | PSR                | 05/16/2016         | Added Thermal Resistance.<br>Updated to new template.  |  |  |  |



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